1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 5 A
- Reverse voltage: V_R ≤ 30 V
- · Low forward voltage
- High power capability due to clip-bond technology
- AEC-Q101 qualified
- Small and flat lead SMD plastic package
- Capable for reflow and wave soldering

3. Applications

- Low voltage rectification
- · High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- Reverse polarity protection
- Low power consumption applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; $T_{sp} \le 135$ °C; square wave	-	-	5	А
V _R	reverse voltage	T _j = 25 °C	-	-	30	V
V _F	forward voltage	I _F = 5 A; T _j = 25 °C	-	400	450	mV
I _R	reverse current	V _R = 30 V; T _j = 25 °C	-	90	250	μΑ



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		к _} А
2	А	anode	1 2	sym001
			CFP5 (SOD128)	

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number Package						
	Name	Description	Version			
PMEG3050BEP	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128			

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG3050BEP	A8

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	30	V
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; $T_{amb} \le 20$ °C; square wave	[1]	-	5	А
		δ = 0.5; f = 20 kHz; $T_{sp} \le 135$ °C; square wave		-	5	А
I _{FSM}	non-repetitive peak forward current	t_p = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	70	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	625	mW
			[3]	-	1.05	W
			[1]	-	2.1	W
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

- Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint. Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
uiu-a)	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	200	K/W
			[3] [2]	-	-	120	K/W
			[4] [2]	-	-	60	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		<u>[5]</u>	-	-	12	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- Device mounted on a ceramic PCB, $\bar{\text{Al}}_2\text{O}_3$, standard footprint.
- Soldering point of cathode tab.

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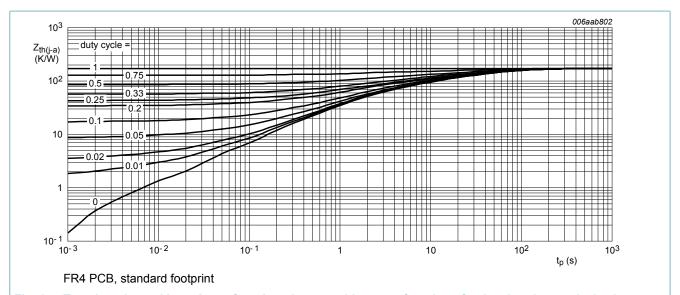


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

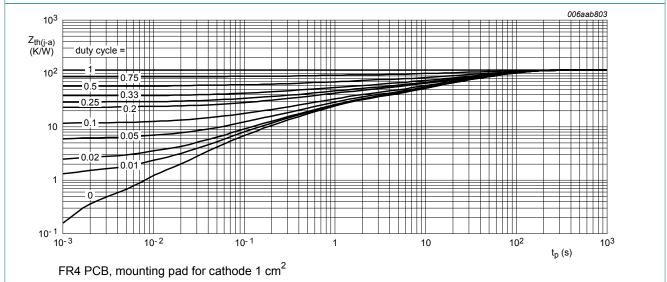
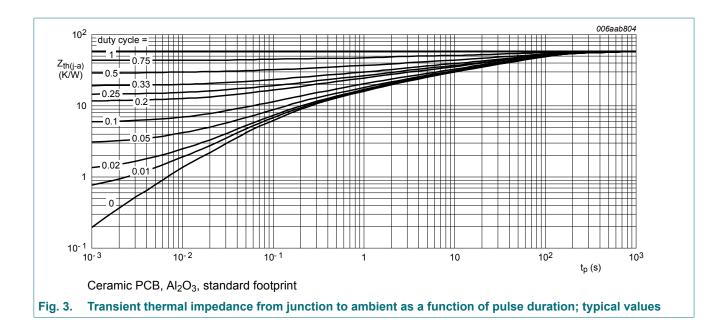


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I _F = 0.1 A; T _j = 25 °C	-	270	300	mV
		I _F = 0.5 A; T _j = 25 °C	-	315	360	mV
		I _F = 1 A; T _j = 25 °C	-	335	380	mV
		I _F = 2 A; T _j = 25 °C	-	360	420	mV
		I _F = 3 A; T _j = 25 °C	-	380	440	mV
		I _F = 5 A; T _j = 25 °C	-	400	450	mV
I _R	reverse current	V _R = 5 V; T _j = 25 °C	-	10	-	μΑ
		V _R = 10 V; T _j = 25 °C	-	15	-	μΑ
		V _R = 30 V; T _j = 25 °C	-	90	250	μΑ
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	800	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	275	-	pF

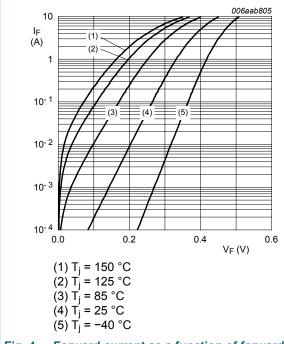


Fig. 4. Forward current as a function of forward voltage; typical values

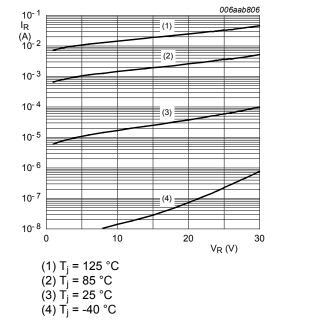


Fig. 5. Reverse current as a function of reverse voltage; typical values

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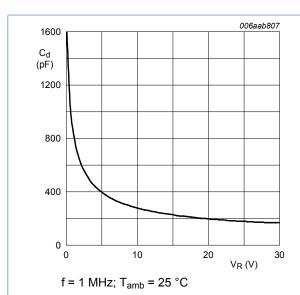


Fig. 6. Diode capacitance as a function of reverse voltage; typical values

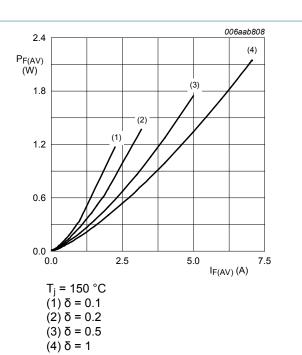
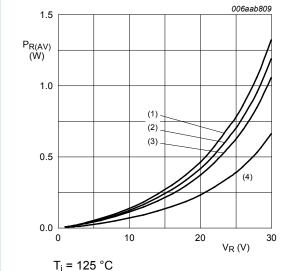
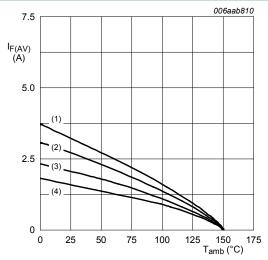


Fig. 7. Average forward power dissipation as a function of average forward current; typical values



 $f_j = 125$ C $(1) \delta = 1$ $(2) \delta = 0.9$ $(3) \delta = 0.8$ $(4) \delta = 0.5$

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint $T_j = 150 \, ^{\circ}\text{C}$

 $(1) \delta = 1; DC$

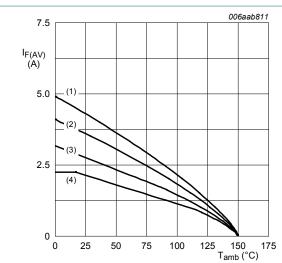
(2) δ = 0.5; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values

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FR4 PCB, mounting pad for cathode 1 cm²

 $T_i = 150 \,{}^{\circ}\text{C}$

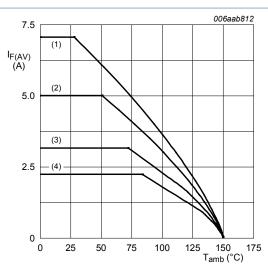
 $(1) \delta = 1; DC$

 $(2) \delta = 0.5$; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

 $T_i = 150 \,^{\circ}C$

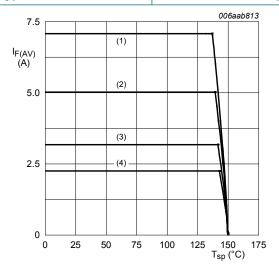
 $(1) \delta = 1; DC$

(2) δ = 0.5; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



 $T_i = 150 \, ^{\circ}C$

 $(1) \delta = 1; DC$

(2) δ = 0.5; f = 20 kHz

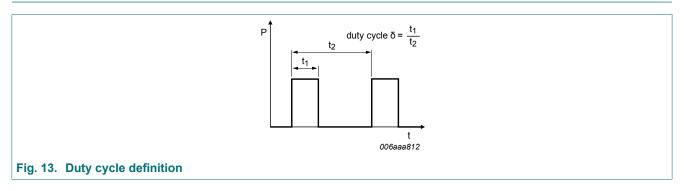
(3) δ = 0.2; f = 20 kHz

(4) δ = 0.1; f = 20 kHz

Fig. 12. Average forward current as a function of solder point temperature; typical values

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11. Test information

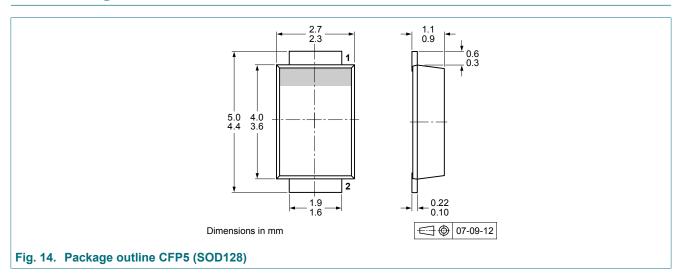


The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

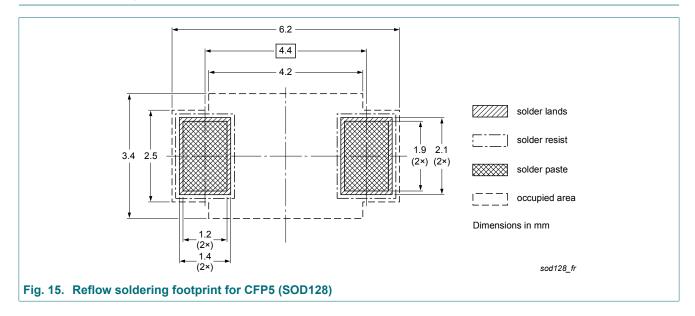
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

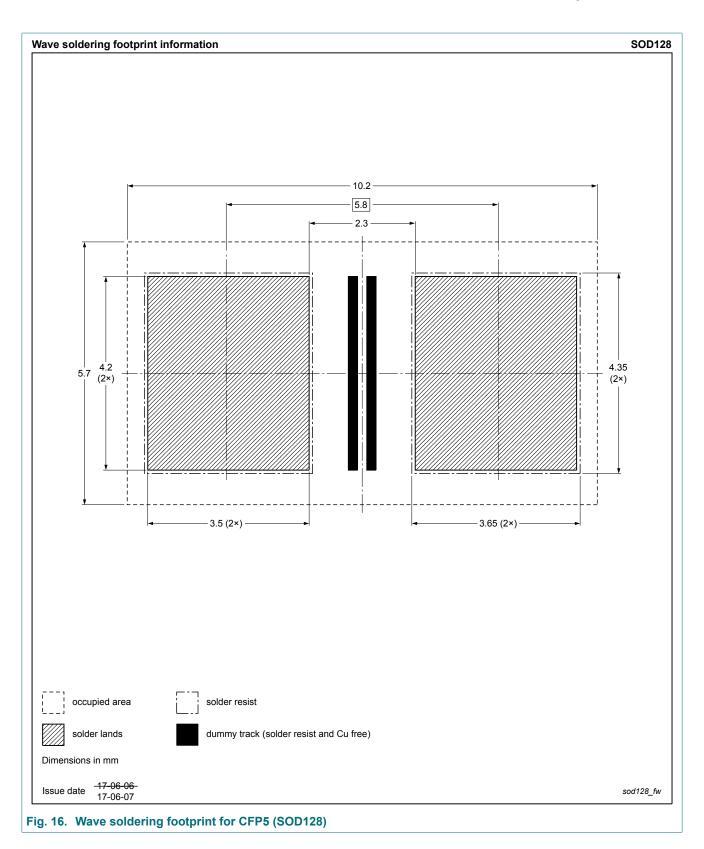
12. Package outline



13. Soldering



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14. Revision history

Table 8. Revision history

- table of the total motor,								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMEG3050BEP v.2	20180528	Product data sheet	-	PMEG3050BEP_1				
Modifications:	 Features and benefits: Capable for reflow and wave soldering added Soldering: Wave soldering footprint added 							
PMEG3050BEP_1	20091028	Product data sheet	-	-				

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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